Experimental Validation of Induction Heating of MS Tube for Elevated Temperature NDT Application

Introduction: Induction heating is non contact type heating techniques. It is widely utilized in industries in various applications such as heating, forging, melting, welding, crystal growth etc, of high efficiency, cleanness and easy control[1] because Therefore, induction heating is preferred to heat the different size of specimens for conducting elevated temperature non destructive testing (NDT).









Figure 1. Schematic Diagram of induction heating system

Computational Methods: Induction heating is coupled field phenomena, i.e combination of electromagnetism and heat transfer [2][3]. Both the physics are nonlinearly coupled with each other due to temperature dependent material properties.

Electromagnetism

$$\frac{1}{\mu(T)} \nabla^2 A - J_s + j \omega \sigma(T) A = 0$$
 (1)

$$Q = \frac{J_e^{-}}{\sigma(T)} = \sigma(T)(j\omega A)^2$$
(2)

Heat transfer
$$K(T)$$
. $\nabla^2 T$) + $Q = \rho c_p(T) \frac{\partial T}{\partial t}$ (3)

Convection heat loss

Figure 5. Mild steel physical properties

Table-I Sr.No. Boundary condition Description Outer boundary A=0 $\frac{\partial A}{\partial n} = 0$ Asymmetry axis 2. 0 to 270 sec=49.93 A Induction coil current 270 to 1110 Sec=94.31 A

Table-II

Sr.No.	Boundary conditions	Description
1.	Initial temperature	312 DegK





Figure 3. Simulation procedure



optimization of induction heating process. **References**:

[1]. Valery Rudnev, Don loveless, Raymond Cook, Micah Black, "Handbook of Induction heating", INDUCTOHEAT, Inc., Madison Heights, Michigan, U.S.A. [2]. C Chabodez, S Clain, R.Glardon, D, D Mari, J.Rappaz, M. Swierkosz, "Numerical modeling in induction heating for IEEE geometries", axisymmetric transactions on Magnetics.Vol33, No.1 January 1997, P 739-745. [3]. J.Y Jang, Y.W.Chiu, Numerical and experimental thermal analysis for a metallic hollow cylinder subjected to step-wise electro-magnetic induction heating, Applied thermal engineering 2007, 1883-1894.

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